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Industrijska omrežja - Enožični digitalni komunikacijski vmesnik za male senzorje in dajalnike - 2. del: Funkcijska varnost podaljškov

Industrial networks - Single-drop digital communication interface - Part 2: Functional safety extensions

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ICS:

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35.110	Omreževanje	Networking

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65C/1113/CDV

COMMITTEE DRAFT FOR VOTE (CDV)

PROJECT NUMBER: **IEC 61139-2 ED1**	
DATE OF CIRCULATION: **2021-09-03**	CLOSING DATE FOR VOTING: **2021-11-26**
SUPERSEDES DOCUMENTS: **65C/1081/CD, 65C/1094A/CC**	

IEC SC 65C : INDUSTRIAL NETWORKS	
SECRETARIAT: France	SECRETARY: Ms Valérie DEMASSIEUX
OF INTEREST TO THE FOLLOWING COMMITTEES: SC 65A,SC 65B	PROPOSED HORIZONTAL STANDARD: ☐ Other TC/SCs are requested to indicate their interest, if any, in this CDV to the secretary.

FUNCTIONS CONCERNED:

☐ EMC ☐ ENVIRONMENT ☐ QUALITY ASSURANCE ☐ SAFETY

☒ SUBMITTED FOR CENELEC PARALLEL VOTING ☐ NOT SUBMITTED FOR CENELEC PARALLEL VOTING

Attention IEC-CENELEC parallel voting

The attention of IEC National Committees, members of CENELEC, is drawn to the fact that this Committee Draft for Vote (CDV) is submitted for parallel voting.

The CENELEC members are invited to vote through the CENELEC online voting system.

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Recipients of this document are invited to submit, with their comments, notification of any relevant patent rights of which they are aware and to provide supporting documentation.

TITLE:

Industrial networks – Single-drop digital communication interface – Part 2: Functional safety extensions

PROPOSED STABILITY DATE: 2025

NOTE FROM TC/SC OFFICERS:

NC comments on this CDV will be resolved during the next SC65C/PT61139-2 meeting currently scheduled as a series of web meetings on November 23rd-25th, 2021. Corresponding meeting notice will be provided in due time by the convenor.

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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INDUSTRIAL NETWORKS – SINGLE-DROP DIGITAL COMMUNICATION INTERFACE –

Part 2: Functional safety extensions

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The text of this International Standard is based on the following documents:

Draft	Report on voting
65C/XX/FDIS	65C/XX/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

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